imall

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IGP50N60T IGW50N60T

PG-TO-247-3

GCE

GCE

PG-TO-220-3-1

Low Loss IGBT in TrenchStop[®] and Fieldstop technology

- Very low V_{CE(sat)} 1.5 V (typ.) •
- Maximum Junction Temperature 175 °C
- Short circuit withstand time 5µs
- Designed for :
 - Frequency Converters
 - Uninterrupted Power Supply
- TrenchStop® and Fieldstop technology for 600 V applications offers :
 - very tight parameter distribution
 - high ruggedness, temperature stable behavior
 - very high switching speed
 - low V_{CE(sat)}
- Positive temperature coefficient in $V_{CE(sat)}$
- Low EMI
- Low Gate Charge ٠
- Qualified according to JEDEC¹ for target applications •
- Pb-free lead plating; RoHS compliant •
- Complete product spectrum and PSpice Models : http://www.infineon.com/igbt/

Туре	V _{CE}	I _c	V _{CE(sat), Tj=25°C}	T _{j,max}	Marking	Package
IGP50N60T	600 V	50 A	1.5 V	175 °C	G50T60	PG-TO-220-3-1
IGW50N60T	600 V	50 A	1.5 V	175 °C	G50T60	PG-TO-247-3

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CE}	600	V
DC collector current, limited by T _{jmax}	I _C		А
$T_{\rm C}$ = 25°C		100	
$T_{\rm C}$ = 100°C		50	
Pulsed collector current, t_p limited by T_{jmax}	<i>I</i> _{Cpuls}	150	
Turn off safe operating area ($V_{CE} \le 600V$, $T_j \le 175^{\circ}C$)	-	150	
Gate-emitter voltage	V _{GE}	±20	V
Short circuit withstand time ²⁾	t _{sc}	5	μS
V_{GE} = 15V, $V_{\text{CC}} \le 400$ V, $T_{j} \le 150^{\circ}$ C			
Power dissipation $T_{\rm C}$ = 25°C	P _{tot}	333	W
Operating junction temperature	Tj	-40+175	°C
Storage temperature	T _{stg}	-55+175	
Soldering temperature, 1.6mm (0.063 in.) from case for 10s	-	260	

¹ J-STD-020 and JESD-022 ²⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



IGP50N60T IGW50N60T

Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic	·			
IGBT thermal resistance,	R _{thJC}		0.45	K/W
junction – case				
Thermal resistance,	R _{thJA}	PG-TO-220-3-1	62	
junction – ambient		PG-TO-247-3-21	40	

Electrical Characteristic, at T_j = 25 °C, unless otherwise specified

Deveryoter	Symphol	Conditions	Value			11
Parameter	Symbol	Conditions	min.	Тур.	max.	Unit
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{\rm GE}$ =0V, $I_{\rm C}$ =0.2mA	600	-	-	V
Collector-emitter saturation voltage	V _{CE(sat)}	$V_{\rm GE}$ = 15V, $I_{\rm C}$ =50A				
		<i>T</i> _j =25°C	-	1.5	2.0	
		<i>T</i> _j =175°C	-	1.9	-	
Gate-emitter threshold voltage	V _{GE(th)}	$I_{\rm C}$ =0.8mA, $V_{\rm CE}$ = $V_{\rm GE}$	4.1	4.9	5.7	
Zero gate voltage collector current	I _{CES}	V _{CE} =600V, V _{GE} =0V				μA
		<i>T</i> _j =25°C	-	-	40	
		<i>T</i> _j =175°C	-	-	1000	
Gate-emitter leakage current	I _{GES}	$V_{CE}=0V, V_{GE}=20V$	-	-	100	nA
Transconductance	g fs	V _{CE} =20V, <i>I</i> _C =50A	-	31	-	S
Integrated gate resistor	R _{Gint}			-		Ω

Dynamic Characteristic

Input capacitance	Ciss	V _{CE} =25V,	-	3140	-	pF
Output capacitance	Coss	V _{GE} =0V,	-	200	-	
Reverse transfer capacitance	Crss	f=1MHz	-	93	-	
Gate charge	Q _{Gate}	V _{CC} =480V, <i>I</i> _C =50A	-	310	-	nC
		V _{GE} =15V				
Internal emitter inductance	LE	PG-TO-220-3-1	-	7	-	nH
measured 5mm (0.197 in.) from case		PG-TO-247-3-21	-	13	-	
Short circuit collector current ¹⁾	I _{C(SC)}	V_{GE} =15V, t_{SC} ≤5µs V_{CC} = 400V, T_j ≤ 150°C	-	458.3	-	A

¹⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



IGP50N60T IGW50N60T

Switching Characteristic, Inductive Load, at Ti=25 °C

Parameter	Symbol	Conditions	Value			11
			min.	Тур.	max.	Unit
IGBT Characteristic		·				
Turn-on delay time	t _{d(on)}	<i>T</i> _j =25°C,	-	26	-	ns
Rise time	t _r	$V_{CC} = 400 V, I_C = 50 A,$ $V_{GE} = 0/15 V,$ $R_G = 7 \Omega,$ $L_{\sigma}^{-1} = 103 n H,$ $C_{\sigma}^{-1} = 39 p F$ Energy losses include "tail" and diode reverse recovery. ²⁾	-	29	-	7
Turn-off delay time	$t_{d(off)}$		-	299	-	
Fall time	tf		-	29	-	
Turn-on energy	Eon		-	1.2	-	mJ
Turn-off energy	E _{off}		-	1.4	-	1
Total switching energy	Ets		-	2.6	-	

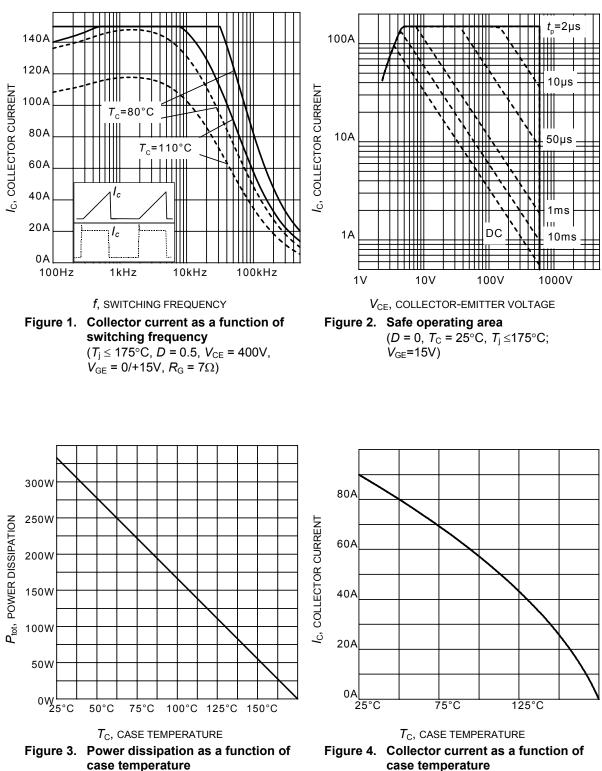
Switching Characteristic, Inductive Load, at T_i=150 °C

Parameter	Symbol	Conditions	Value			Unit
Parameter			min.	Тур.	max.	
IGBT Characteristic						
Turn-on delay time	t _{d(on)}	<i>T</i> _j =175°C,	-	27	-	ns
Rise time	tr	$V_{CC} = 400V, I_C = 50A,$ $V_{GE} = 0/15V,$ $R_G = 7 \Omega$ $L_{\sigma}^{(1)} = 103nH,$ $C_{\sigma}^{(1)} = 39pF$ Energy losses include "tail" and diode reverse recovery. ²⁾	-	33	-	7
Turn-off delay time	$t_{d(off)}$		-	341	-	
Fall time	t _f		-	55	-	
Turn-on energy	Eon		-	1.8	-	mJ
Turn-off energy	E _{off}		-	1.8	-	
Total switching energy	Ets		-	3.6	-	

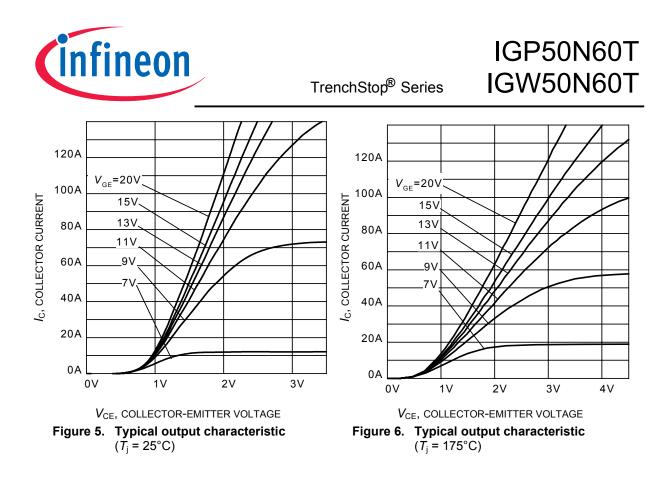
¹⁾ Leakage inductance L_{σ} and Stray capacity C_{σ} due to dynamic test circuit in Figure E. ²⁾ Includes Reverse Recovery Losses from IKW50N60T due to dynamic test circuit in Figure E.

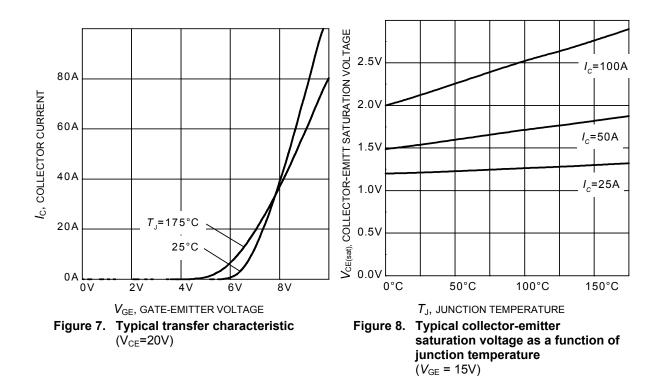


IGP50N60T IGW50N60T

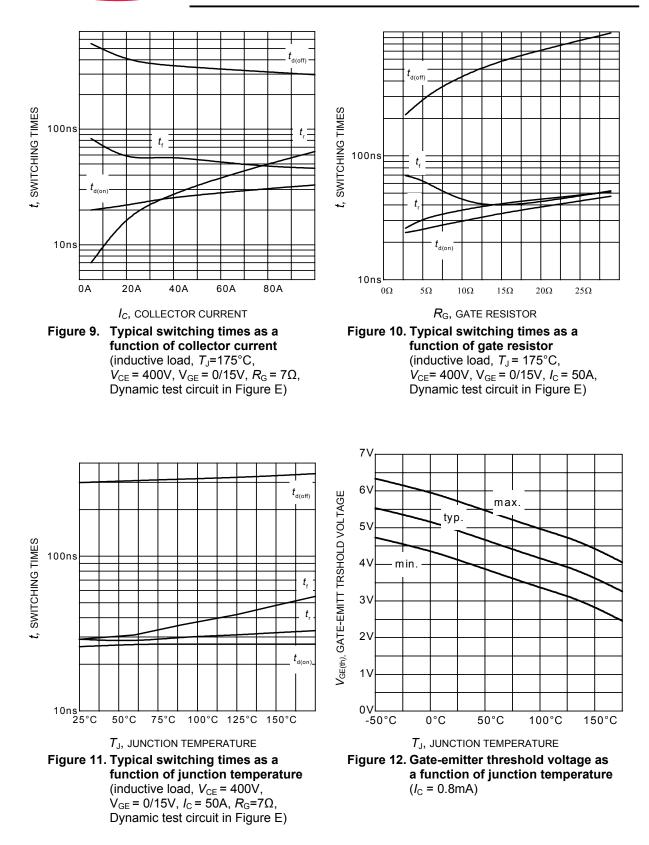


 $(T_i \le 175^{\circ}C)$



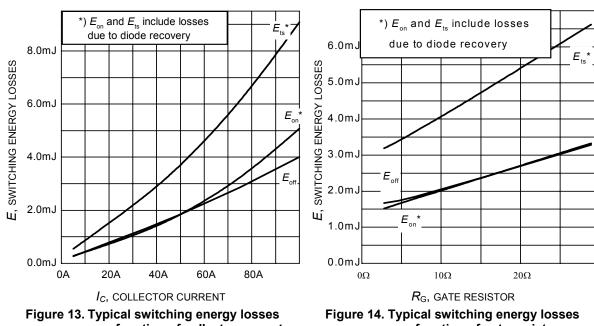




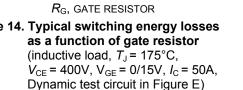


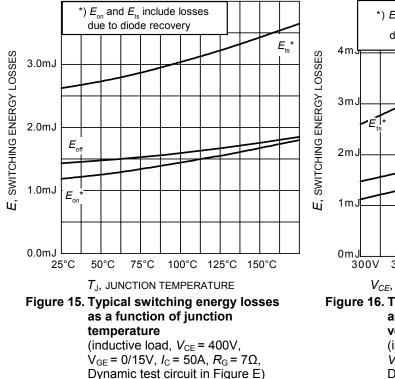


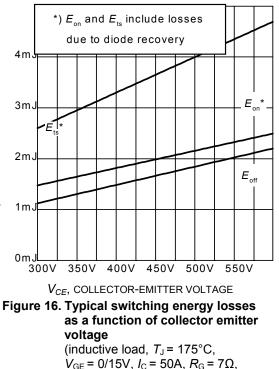
IGP50N60T IGW50N60T



as a function of collector current (inductive load, $T_J = 175^{\circ}C$, $V_{CE} = 400V$, $V_{GE} = 0/15V$, $R_G = 7\Omega$, Dynamic test circuit in Figure E)

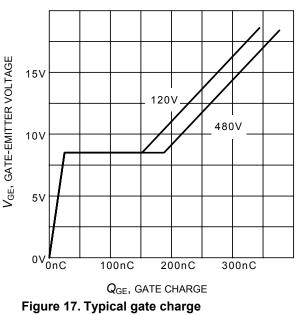


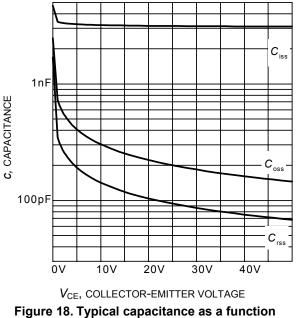




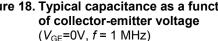
Dynamic test circuit in Figure E)

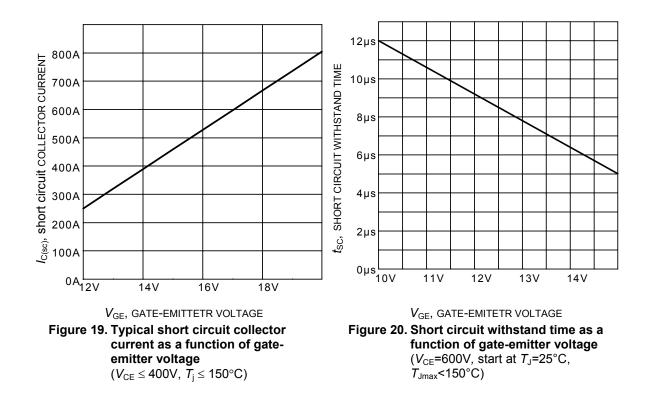




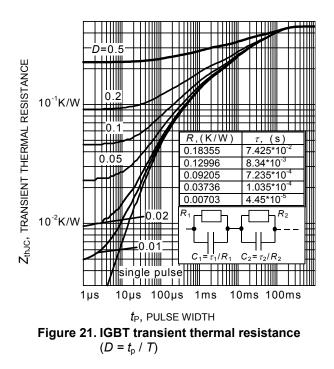


e 17. Typical gate charge (I_C=50 A)

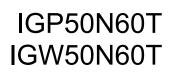




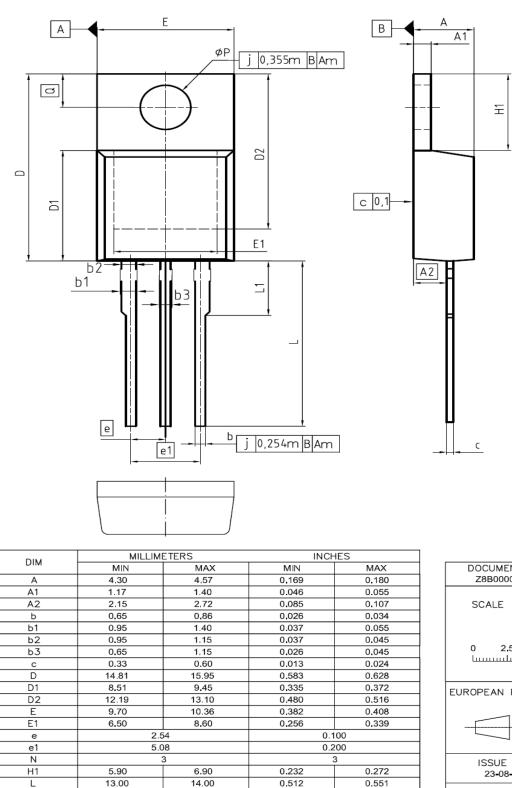


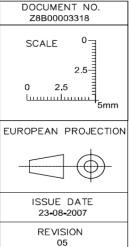












-

3.60

2.60

L1

øP

Q

-

0.142

0.102

0.189

0.153

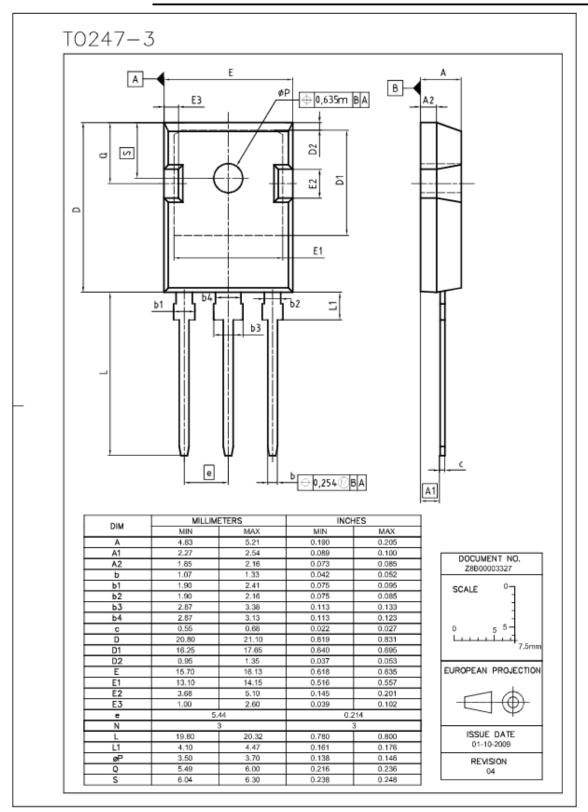
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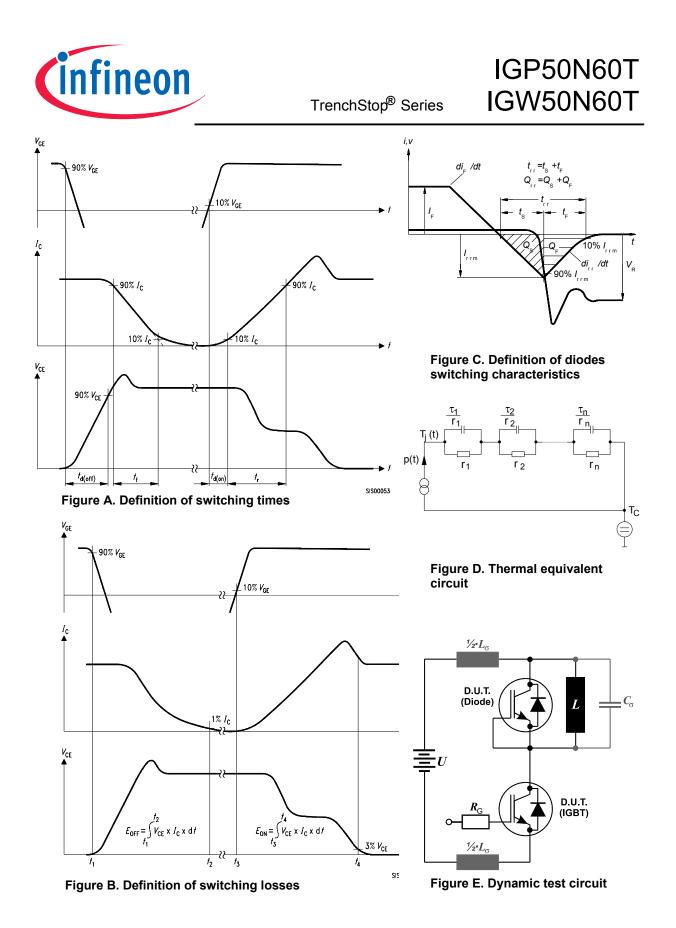
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3.00









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